Harvatek Surface Mount CHIP LEDs Approval Sheet Model No.: HT-121NB

Acknowledged by

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Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	****	HDS-121-K204	
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INTRODUCTION	
PRODUCT SPECIFICATION	4
ATTENTION: ELECTRICSTATIC DISCHARGE (ESD) PROTECTION	4
LABEL SPEC.:	5
PRODUCT FEATURE	7
ELECTRO-OPTICAL CHARACTERISTICS PACKAGE OUTLINE DIMENSION AND RECOMMENDED SOLDERING PATTERN FOR REFLOW	
Soldering Absolute Maximum Ratings	
CHARACTERISTICS OF HT-121 SERIES	
PACKAGING TAPE, REEL, AND PACKING MODEL	9
TAPE DIMENSION	
PACKING MODEL	10
DRY PACK	11
CAUTIONS OF PICK AND PLACE	11
PRECAUTIONS	11
RE-FLOW SOLDERING	12
LEAD SOLDER	12
REWORK Cleaning Cautions of Pick and Place	13

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	****	HDS-121-K204	
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 2/13

Introduction

- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual property or other rights of the third parties which may result from it use.
- Harvatek is continually effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARATEK products cause loss of human life, bodily injury or damage to property.
- The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury.
- In developing your designs, please ensure that HARVATEK products are used within specified operating ranges as set forth in the most recent HARVATEK products specifications.
- Also, please keep in mind the precautions listed in this document.

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	****	HDS-121-K204	
Specifications are subj without advance notice. company confidential all	Jan-19, 2005	Version of 1.0	Page 3/13	

Product Specification

	Specification	Material	Quantity
lv	45-180 mcd		
	@20mA/ Ta= 25 ⁰ C		
	Tolerance: <u>+</u> 10%		
lambda(λ_D)	464-480 nm		
	@20mA/ Ta= 25 ⁰ C		
	Tolerance: <u>+</u> 0.5nm		
Vf	2.7-3.9V(0.2V/1Bin)		
	@20mA/25°C		
	Tolerance: <u>+</u> 0.05V		
lr	HT standard		
Resin	Water Clear	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	According to EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

Every mid-box will be loaded 5 reels. These 5 reels can be different in lot, Iv, lambda, or Vf. Every reel will have an independent label to identify its specification and the mid-box there will have a corresponding label post on it.

ATTENTION: Electricstatic Discharge (ESD) protection



The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP,

GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	****	HDS-121-K204	
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 4/13

Label Spec.:

HARVATEK	k	Date: yyyy/mm/dd
CUSTOMER P/N:		
HARVATEK P/N:		QTY: PCS
		QC
IV BIN: COLOR BIN	: VF:	

Customer P/N: To Be Defined



H T - 1 2 1 NB



Series Name	Emitting Color
HT-121: 1.6x0.6x1.0mm	NB:
H1-121: 1.6X0.6X1.0MM	InGaN Blue

Ł

Lot No.

Ρ	1	2	2	3	0	Α	-	С	Т
1	2	3	4	5	6	7	8	9	10

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
		1: Jan.				
	Z: 2000	2: Feb.				
Internal	1: 2001			01 00		
Internal Tracing Code	2: 2002	9: Sep.	1~31/ (30)	01~99,	C: Water Clear	T: Taped Reel
Tracing Code	3: 2003	A: Oct.		A,B,C		
		B: Nov.				
		C: Dec.				

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	****	HDS-121-K204	
	ect to changes for improvement . Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 5/13

Iv Bin:

Color	Bin Code	Spec. Range
	Р	45-72mcd
Blue	Q	72-112.5mcd
	R	112.5-180mcd

Color Bin:

Color	Bin Code	Spec. Range
	В	464-468nm
Blue	С	468-472nm
Blue	D	472-476nm
	E	476-480nm

Vf Bin:

Color	Bin Code	Spec. Range		
	G8	2.7-2.9V		
	H7	2.9-3.1V		
DI	H8	3.1-3.3V		
Blue	J7	3.3-3.5V		
	J8	3.5-3.7V		
	K7	3.7-3.9V		

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
, , , , , , , , , , , , , , , , , , , ,	ect to changes for improvement . Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 6/13

Product Feature

Electro-Optical Characteristics

						(IF	<u>@ 20mA, Ta</u>	<u>25°C)</u>
Code for parts Lighting Color	Lighting Color	Material	V _F (V)		λ (nm)			I [*] _V (mcd)
			typ	max	λD	λp	$ riangle \lambda$	Тур
HT-121NB	Blue	InGaN	3.3	3.9	472	470	40	72

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1 Outline Dim. Soldering Pattern Cathode mark Cathode side 0.60 0.40 Cathode 0.8 10.4 Resin R 0.55 0.30 C 4 LED Die Ö 80 0.20 Ó 1.60 1.10 0:30 0.8 0.6 0.6 Polarity 30 R 0.20 PCB 1.00

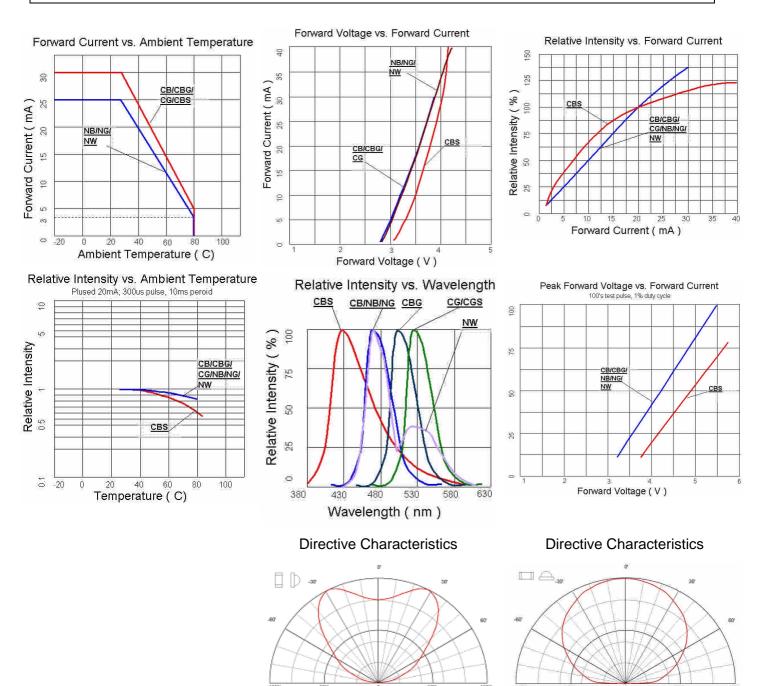
Soldering terminal may shift in x, y direction.

Absolute Maxin	Absolute Maximum Ratings							
							(Ta 25 °C)	
Series	P _d (mW)	I _F (mA)	I _{FP} (mA)	V _R (V)	I _R (uA)	T _{OP} (°C)	T _{ST} (°C)	
HT-121NB	78	20	100**	5	<100@ V _R = 5	-30~+80	-40~+85	

** Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

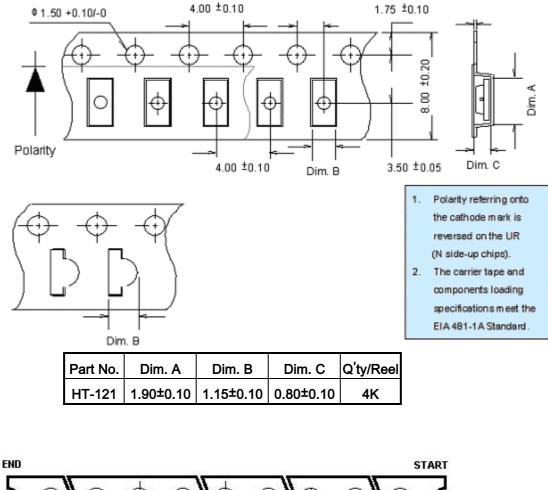
Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 7/13

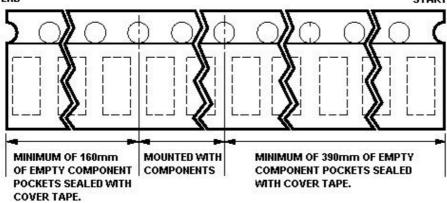
Characteristics of HT-121 Series



Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 8/13

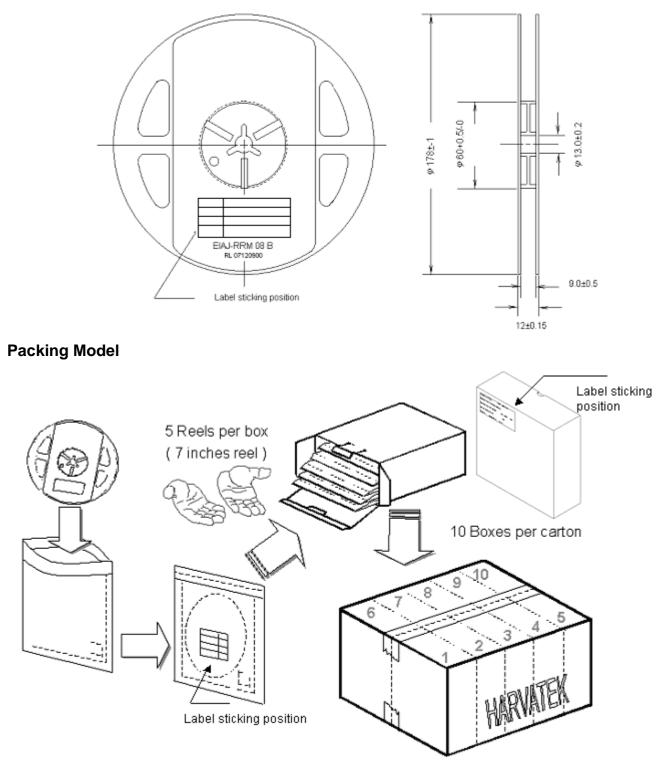
Packaging Tape, Reel, and Packing Model Tape Dimension





Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement . Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 9/13

Reel Dimension



5 boxes per carton is available according to shipping quantity.

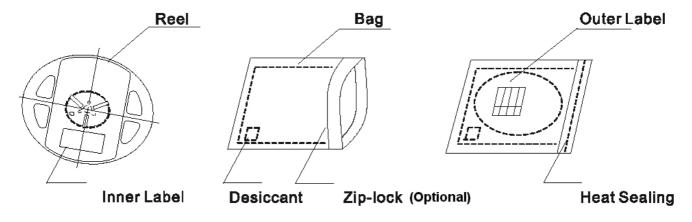
Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 10/13

Dry Pack

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:



Cautions of Pick and Place

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

PRECAUTIONS

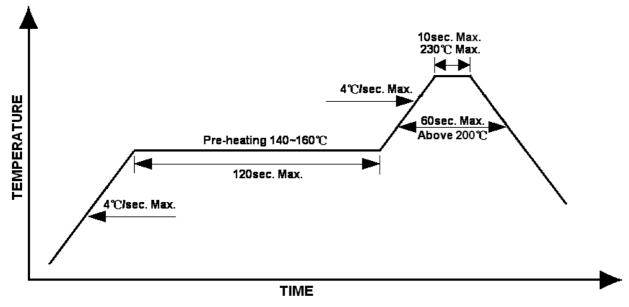
- 1. Avoid absorbing moisture at any time during transportation or storage.
- 2. Anti-Static process is needed especially when handling GaN, InGaN, and AlInGaP products.
- 3. It is suggested to connect the unit with a proper series current limit resistor. Avoid driving reverse voltage over the specification of LEDs when turning the unit ON/OFF.
- 4. Any application should refer to the specifications of absolute maximum ratings.
- 5. Avoid any direct contact with the viewing area.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

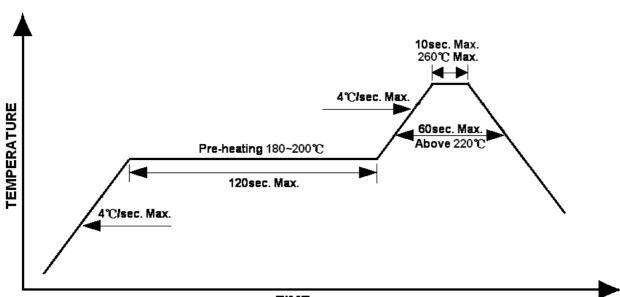
Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 11/13

Re-flow Soldering

- Recommend tin glue specifications: Melting temperature: 178~192 ^OC
- Never take next process until the component is cooled down to room temperature after re-flow.
- The recommended re-flow soldering profile (measuring on the surface of the LED resin) is following:

Lead Solder





Lead-free Solder

TIME

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 12/13

Rework

- Customer must finish rework within 5 sec. under 260 °C.
- The head of iron cannot touch copper foil.
- Twin-head type is preferred.

Cleaning

The conditions of cleaning after soldering: An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended. Temperature×Time: <50 ^oC×30sec, or <30 ^oC×3min Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max. Curing: 100 ^oC max, <3min Do not contact with component on the assembly board.

Cautions of Pick and Place

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

Official Product	HT Part No. HT-121NB	Your Part No.		Data Sheet No.
Tentative Product	*****	*****		HDS-121-K204
	ect to changes for improvement Proprietary data, drawings, and rights reserved.	Jan-19, 2005	Version of 1.0	Page 13/13